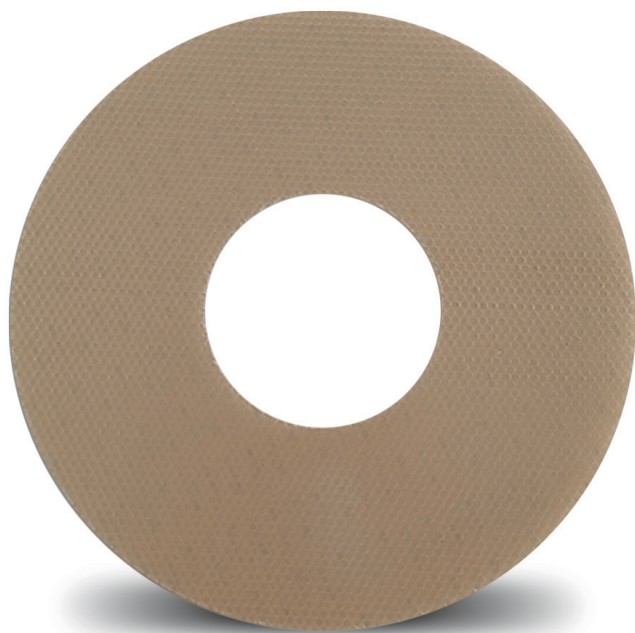
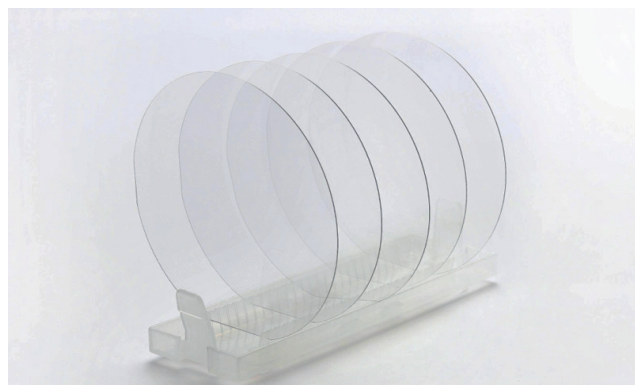
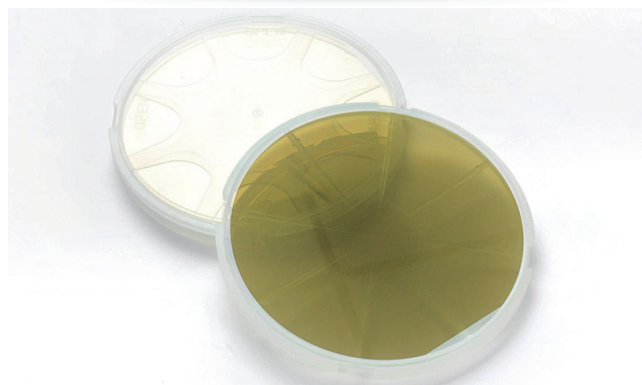


Resin Polishing Pad



Hexagon Resin Pad with BD--Diamond Polishing Slurry for Sapphire, SiC, glassy and crystals materials.

Which mainly used with BD-009 Polishing Slurry; As an effective polish tool for lapping section of plane grinding; It can better store liquid and increase grinding efficiency of the plane by 50%.



Code	NP-100
Application Category	Sapphire, SiC , glassy materials and crystals
Attachment Type	PSA
Brand	More Superhard
Color	White
Equipment – Machines	Biplanar Grinder
Overall Diameter (Imperial)	1290mm×350mm
Thickness	Total thickness 2.34mm, plate thickness 2.24mm side length 1.1mm, spacing 1.77mm

Product Features

1. The honeycomb grid groove structure is uniform.
2. The back adhesive is resistant to high temperatures, has strong adhesion, easy to replace the disc without leaving residue on the surface.
3. Higher polishing accuracy.
4. Deep depth blind holes, longer life.
5. The hole spacing is optimized to the best, polishing with polycrystalline diamond liquid.
6. It can replace the copper disc process, energy-saving, environmentally friendly, pollution-free.